



This document provides information about the cleaning compatibility between some Interflux soldering products and Kolb cleaners.

Soldering Flux	Cleaner	Kolb MultiEx BC 1:2	Kolb MultiEX A12	Kolb MultiEx B 11 1:2,5
IF2005M		+	+	+
IF2005C		+	+	+
P2009M		+	++	+
P2009MLF		++	+	++
AF4818PbF		--	+	+

Solder Paste	Cleaner	Kolb MultiEX VR	Kolb MultiEX 3DE14 HPA
DP5505		+	+
LP5707		+	++
DP5600		+	--

Solder Wire	Cleaner	Kolb MultiEX VR	Kolb MultiEX 3DE14 HPA	Kolb MultiEx B 11 1:2,5	Kolb MultiEX VR-SP
IF14-16		++	++	-	+
Flexsol 903 3,5%		++	++	++	+

++	: Good Cleaning
+	: Possible
-	: Limited
--	: Not Recommended

Cleaning parameters

Temperature : 45°C

Time : 45min

**NOTE**

The composition and structure of residues after a soldering process may differ from case to case. The influencing parameters can be:

- Residues from the solder mask
- Residues from components
- Residues from other soldering chemistry on the board
- Residues from carriers
- Residues from machine pollution
- Temperature profile of the soldering process
- Amount of used soldering chemistry (due to e.g. thermally heavy boards)
- ...

To get optimal cleaning results, it is possible that cleaning parameters will have to be adapted.